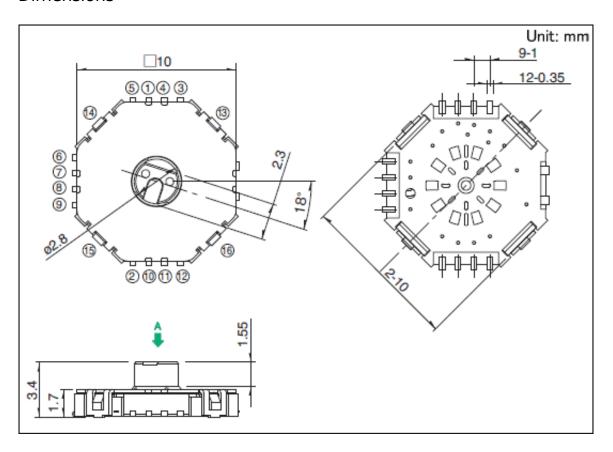


Heavy-torque Feel, Low-profile Type SRBD Series

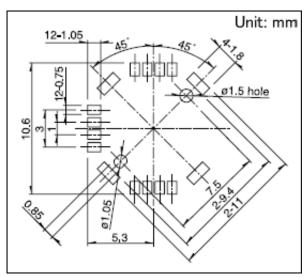
Part number		SRBD170401		
Poles		1		
Positions		10		
Changeover angle		36°		
Detent		7		
Location lug		without		
Changeover timing	9	Non shorting		
Rotational torque		13±5mN·m		
Soldering		For PC board (Reflow)		
Actuator length		1.7mm		
Operating temperature range		-25℃ to +85℃		
Rating (max.)/(min.) (Resistive load)		1mA 5V DC/50μA 3V DC		
Electrical performance	Contact resistance (Initial performance/After lifetime)	200m Ω max./200m Ω max.		
	Insulation resistance	100MΩ min. 100V DC		
	Voltage proof	100V AC for 1 minute		
Mechanical performance	Terminal strength	3N for 1 minute		
	Actuator strength Push direction	50N		
Durability	Operating life without load	10,000 cycles 250m Ω max.		
	Operating life with load (at max. rated load)	10,000 cycles 250m Ω max.		

Environmental performance	Cold		-40±2℃ for 500h
	Dry heat		85±2℃ for 500h
	Damp he	at	60±2℃, 90 to 95%RH for 500h
Minimum order unit (pcs.)		Japan	1,200
		Export	4,800

Dimensions

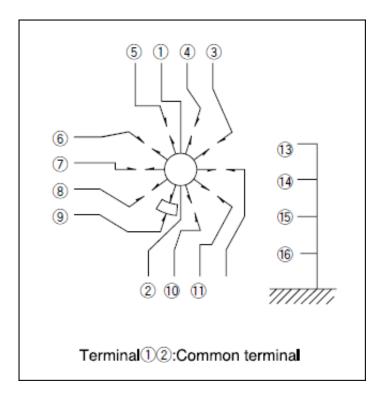


Mounting Hole Dimensions



Viewed from direction A in the dimensions.

Circuit Diagram

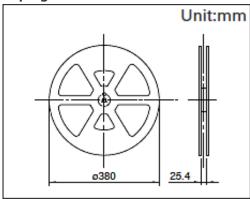


Correspondence Table of Terminal No. and Detent

position No	Terminal No.	Detent			
position No.		5	7	8	10
1	3	_	0	_	0
2	4	_	0	0	0
3	(5)	_	0	0	0
4	6	0	0	0	0
5	7	0	0	0	0
6	8	0	0	0	0
7	9	0	0	0	0
8	10	0	_	0	0
9	11)	_	_	0	0
10	12	_	_	_	0

Packing Specifications





Number of packages (pcs.)	1 reel	1,200
	1 case / Japan	2,400
	1 case / export packing	4,800
Tape width (mm)		24
Export package measurements (mm)		428×413×172

Soldering Conditions

Example of Reflow Soldering Condition

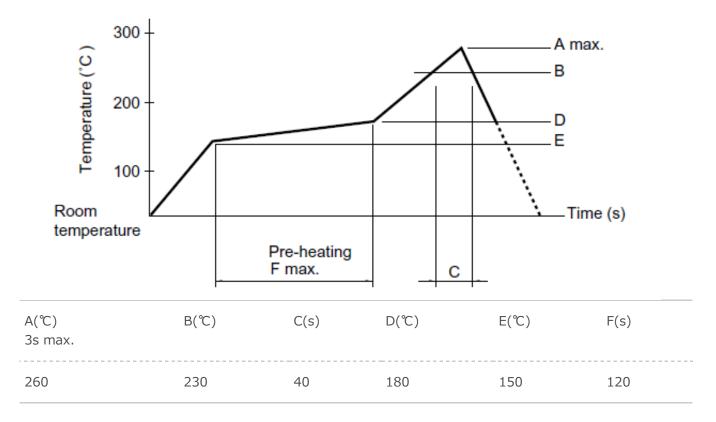
1. Heating method

Double heating method with infrared heater.

2. Temperature measurement

Thermocouple 0.1 to 0.2 Φ CA (K) or CC (T) at soldering portion (copper foil surface). A heat resisting tape should be used for fixed measurement.

3. Temperature profile



- (1) The condition mentioned above is the temperature on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the PC board's material, size, thickness, etc. The above-stated conditions shall also apply to switch surface temperatures.
- (2) Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Notes are common to this series/models.

- 1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
- 2. Please place purchase orders per minimum order unit (integer).

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